



Doc. Number :						
	Tentative Specification					
	Preliminary Specification					
	Approval Specification					

MODEL NO.: M238HCA SUFFIX: L5Z

Customer:	
APPROVED BY	SIGNATURE
Name / Title Note Product Version C1	
Please return 1 copy for your signature and comments.	our confirmation with your

Approved By	Checked By	Prepared By
阮泰郎	張耀元	趙宗信



CONTENTS

1.1 OVERVIEW 1.2 GENERAL SPECIFICATIONS 2. MECHANICAL SPECIFICATIONS 3. ABSOLUTE MAXIMUM RATINGS 3.1 ABSOLUTE RATINGS OF ENVIRONMENT 3.2 ELECTRICAL ABSOLUTE RATINGS 3.2.1 TFT LCD MODULE 3.2.2 BACKLIGHT UNIT 4. ELECTRICAL SPECIFICATIONS 4.1 FUNCTION BLOCK DIAGRAM 4.2 INTERFACE CONNECTIONS 4.3 ELECTRICAL CHARACTERISTICS 4.3.1 LCD ELETRONICS SPECIFICATION 4.3.2 Vcc Power Dip Condition 4.3.3 BACKLIGHT UNIT 4.3.4 LIGHTBAR Connector Pin Assignment 4.4 LVDS INPUT SIGNAL SPECIFICATIONS 4.4.1 LVDS DATA MAPPING TABLE 4.4.2 COLOR DATA INPUT ASSIGNMENT 4.5 DISPLAY TIMING SPECIFICATIONS 4.6 POWER ON/OFF SEQUENCE 5. OPTICAL CHARACTERISTICS 5.1 TEST CONDITIONS 5.2 OPTICAL SPECIFICATIONS 7.3 DEFINITIONS 7.3 DEFINITIONS 7.3 DEFINITIONS 7.3 DEFINITIONS 7.3 DEFINITION OF TEST POINTS 8.2 PACKING 8.4 PACKING METHOD 9.2 8.4 PACKING METHOD 9.2 8.5 PACKING METHOD 9.2 9.3 PALLET 9.4 UN-PACKAGING METHOD 9.2 9.4 UN-PACKAGING METHOD 9.2 9.4 UN-PACKAGING METHOD 9.2 9.5 PALLET 9.4 UN-PACKAGING METHOD 9.2 9.5 PALLET 9.5 ENVIRONMENT 9.5 ENVIRONMENT 9.5 ENVIRONMENT 9.6 ENVIRONMENT 9.7 E	1.	. GENERAL DESCRIPTION	5
2. MECHANICAL SPECIFICATIONS		1.1 OVERVIEW	5
3. ABSOLUTE MAXIMUM RATINGS 3.1 ABSOLUTE RATINGS OF ENVIRONMENT 3.2 ELECTRICAL ABSOLUTE RATINGS 3.2.1 TFT LCD MODULE 3.2.2 BACKLIGHT UNIT 4. ELECTRICAL SPECIFICATIONS 4.1 FUNCTION BLOCK DIAGRAM 4.2. INTERFACE CONNECTIONS 4.3 ELECTRICAL CHARACTERISTICS 11 4.3.1 LCD ELETRONICS SPECIFICATION 1.4.3.2 Vcc Power Dip Condition 1.4.3.3 BACKLIGHT UNIT 1.4.3.4 LIGHTBAR Connector Pin Assignment 1.4 LVDS INPUT SIGNAL SPECIFICATIONS 1.4.1 LVDS DATA MAPPING TABLE 1.4.2 COLOR DATA INPUT ASSIGNMENT 1.4.5 DISPLAY TIMING SPECIFICATIONS 1.4.6 POWER ON/OFF SEQUENCE 1.5 OPTICAL CHARACTERISTICS 1.5 5.1 TEST CONDITIONS 5.2 OPTICAL STRENGTH CHARACTERISTICS 1.7 7. MECHANICAL STRENGTH CHARACTERISTICS 2.7 7.1 MECHANICAL STRENGTH SPECIFICATIONS 2.7 7.2 TEST CONDITIONS 7.3 DEFINITION OF TEST POINTS 8.4 PACKING 8.1 PACKING 8.2 PACKING 8.3 PALLET 2.2 8.3 PALLET 2.3 2.4 2.5 2.5 2.6 2.7 2.7 2.7 3.7 3.7 3.7 4.7 4.7 4.7 4.7 4		1.2 GENERAL SPECIFICATIONS	5
3.1 ABSOLUTE RATINGS OF ENVIRONMENT	2.	. MECHANICAL SPECIFICATIONS	5
3.2 ELECTRICAL ABSOLUTE RATINGS 3.2.1 TFT LCD MODULE 3.2.2 BACKLIGHT UNIT. 4. ELECTRICAL SPECIFICATIONS 4.1 FUNCTION BLOCK DIAGRAM 4.2. INTERFACE CONNECTIONS 4.3 ELECTRICAL CHARACTERISTICS. 4.3.1 LCD ELETRONICS SPECIFICATION 4.3.2 Vcc Power Dip Condition. 4.3.3 BACKLIGHT UNIT. 4.3.4 LIGHTBAR Connector Pin Assignment 4.4.1 LVDS INPUT SIGNAL SPECIFICATIONS 4.4.1 LVDS DATA MAPPING TABLE 4.4.2 COLOR DATA INPUT ASSIGNMENT. 4.5 DISPLAY TIMING SPECIFICATIONS 4.6 POWER ON/OFF SEQUENCE 5. OPTICAL CHARACTERISTICS 5.1 TEST CONDITIONS 5.2 OPTICAL SPECIFICATIONS 6. RELIABILITY TEST ITEM 7. MECHANICAL STRENGTH CHARACTERISTICS 7.1 MECHANICAL STRENGTH CHARACTERISTICS 7.2 TEST CONDITIONS 7.3 DEFINITION OF TEST POINTS 2.6 RPACKING 2.7 SPACKING 2.8 PACKING 3.9 PALLET. 2.9 PACKING METHOD 3.9 PALLET. 2.9 PACKING METHOD 3.9 PALLET. 3.1 PACKING METHOD 3.9 PALLET. 3.2 PACKING METHOD 3.9 PALLET. 3.1 PACKING METHOD 3.9 PALLET. 3.2 PACKING METHOD 3.9 PALLET. 3.0 PALET. 3.0 PALLET. 3.0 PALET. 3.0 PALLET. 3.0 P	3.	. ABSOLUTE MAXIMUM RATINGS	6
3.2.1 TFT LCD MODULE 3.2.2 BACKLIGHT UNIT		3.1 ABSOLUTE RATINGS OF ENVIRONMENT	6
3.2.2 BACKLIGHT UNIT. 4. ELECTRICAL SPECIFICATIONS		3.2 ELECTRICAL ABSOLUTE RATINGS	7
4. ELECTRICAL SPECIFICATIONS 4.1 FUNCTION BLOCK DIAGRAM 4.1. FUNCTION BLOCK DIAGRAM 4.2. INTERFACE CONNECTIONS 4.3. ELECTRICAL CHARACTERISTICS 11 4.3.1 LCD ELETRONICS SPECIFICATION 1 4.3.2 Vcc Power Dip Condition 1 4.3.3 BACKLIGHT UNIT 1 4.3.4 LIGHTBAR Connector Pin Assignment 1 4.4 LVDS INPUT SIGNAL SPECIFICATIONS 14 4.4.1 LVDS DATA MAPPING TABLE 1 4.4.2 COLOR DATA INPUT ASSIGNMENT 1 4.5 DISPLAY TIMING SPECIFICATIONS 16 4.6 POWER ON/OFF SEQUENCE 16 5. OPTICAL CHARACTERISTICS 15 5.1 TEST CONDITIONS 15 5.2 OPTICAL SPECIFICATIONS 15 6. RELIABILITY TEST ITEM 22 7.1 MECHANICAL STRENGTH CHARACTERISTICS 26 7.2 TEST CONDITIONS 26 7.2 TEST CONDITIONS 26 7.3 DEFINITION OF TEST POINTS 26 8. PACKING 26 8.1 PACKING SPECIFICATIONS 26 8.2 PACKING METHOD 26 8.3 PALLET 26		3.2.1 TFT LCD MODULE	7
4.1 FUNCTION BLOCK DIAGRAM 3 4.2. INTERFACE CONNECTIONS 1 4.3 ELECTRICAL CHARACTERISTICS 11 4.3.1 LCD ELETRONICS SPECIFICATION 1 4.3.2 Vcc Power Dip Condition 1 4.3.3 BACKLIGHT UNIT 1 4.3.4 LIGHTBAR Connector Pin Assignment 1 4.4 LVDS INPUT SIGNAL SPECIFICATIONS 1 4.4.1 LVDS DATA MAPPING TABLE 1 4.4.2 COLOR DATA INPUT ASSIGNMENT 1 4.5 DISPLAY TIMING SPECIFICATIONS 16 4.6 POWER ON/OFF SEQUENCE 15 5. OPTICAL CHARACTERISTICS 15 5.1 TEST CONDITIONS 15 5.2 OPTICAL SPECIFICATIONS 15 6. RELIABILITY TEST ITEM 22 7.1 MECHANICAL STRENGTH CHARACTERISTICS 26 7.2 TEST CONDITIONS 26 7.2 TEST CONDITIONS 26 7.3 DEFINITION OF TEST POINTS 26 8. PACKING 20 8.1 PACKING SPECIFICATIONS 21 8.2 PACKING METHOD 22 8.3 PALLET 26		3.2.2 BACKLIGHT UNIT	7
4.2. INTERFACE CONNECTIONS 3.4.3 ELECTRICAL CHARACTERISTICS 11 4.3.1 LCD ELETRONICS SPECIFICATION 1 4.3.2 Vcc Power Dip Condition 1 4.3.3 BACKLIGHT UNIT 1 4.3.4 LIGHTBAR Connector Pin Assignment 1 4.4.1 LVDS INPUT SIGNAL SPECIFICATIONS 1 4.4.1 LVDS DATA MAPPING TABLE 1 4.4.2 COLOR DATA INPUT ASSIGNMENT 1 4.5 DISPLAY TIMING SPECIFICATIONS 16 4.6 POWER ON/OFF SEQUENCE 18 5. OPTICAL CHARACTERISTICS 19 5.1 TEST CONDITIONS 19 5.2 OPTICAL SPECIFICATIONS 19 6. RELIABILITY TEST ITEM 22 7.1 MECHANICAL STRENGTH CHARACTERISTICS 22 7.2 TEST CONDITIONS 22 7.3 DEFINITION OF TEST POINTS 22 8. PACKING 22 8.1 PACKING SPECIFICATIONS 22 8.2 PACKING METHOD 22 8.3 PALLET 26	4.	ELECTRICAL SPECIFICATIONS	8
4.3 ELECTRICAL CHARACTERISTICS 11 4.3.1 LCD ELETRONICS SPECIFICATION 1 4.3.2 Vcc Power Dip Condition 1 4.3.3 BACKLIGHT UNIT 1 4.3.4 LIGHTBAR Connector Pin Assignment 1 4.4.1 LVDS INPUT SIGNAL SPECIFICATIONS 1 4.4.1 LVDS DATA MAPPING TABLE 1 4.4.2 COLOR DATA INPUT ASSIGNMENT 1 4.5 DISPLAY TIMING SPECIFICATIONS 10 4.6 POWER ON/OFF SEQUENCE 18 5. OPTICAL CHARACTERISTICS 19 5.1 TEST CONDITIONS 19 5.2 OPTICAL SPECIFICATIONS 19 6. RELIABILITY TEST ITEM 2 7.1 MECHANICAL STRENGTH CHARACTERISTICS 2 7.2 TEST CONDITIONS 2 7.3 DEFINITION OF TEST POINTS 2 8. PACKING 2 8.1 PACKING SPECIFICATIONS 2 8.2 PACKING METHOD 2 8.3 PALLET 2			
4.3.1 LCD ELETRONICS SPECIFICATION 1 4.3.2 Vcc Power Dip Condition 1 4.3.3 BACKLIGHT UNIT 1 4.3.4 LIGHTBAR Connector Pin Assignment 1 4.4.2 LVDS INPUT SIGNAL SPECIFICATIONS 14 4.4.1 LVDS DATA MAPPING TABLE 1 4.4.2 COLOR DATA INPUT ASSIGNMENT 1 4.5 DISPLAY TIMING SPECIFICATIONS 16 4.6 POWER ON/OFF SEQUENCE 15 5. OPTICAL CHARACTERISTICS 15 5.1 TEST CONDITIONS 15 5.2 OPTICAL SPECIFICATIONS 15 6. RELIABILITY TEST ITEM 22 7. MECHANICAL STRENGTH CHARACTERISTICS 24 7.2 TEST CONDITIONS 24 7.2 TEST CONDITIONS 24 7.3 DEFINITION OF TEST POINTS 24 8. PACKING 25 8.1 PACKING SPECIFICATIONS 25 8.2 PACKING METHOD 25 8.3 PALLET 26			
4.3.2 Vcc Power Dip Condition 1 4.3.3 BACKLIGHT UNIT 1 4.3.4 LIGHTBAR Connector Pin Assignment 1 4.4 LVDS INPUT SIGNAL SPECIFICATIONS 14 4.4.1 LVDS DATA MAPPING TABLE 1 4.4.2 COLOR DATA INPUT ASSIGNMENT 1 4.5 DISPLAY TIMING SPECIFICATIONS 16 4.6 POWER ON/OFF SEQUENCE 16 5. OPTICAL CHARACTERISTICS 19 5.1 TEST CONDITIONS 19 5.2 OPTICAL SPECIFICATIONS 19 6. RELIABILITY TEST ITEM 22 7. MECHANICAL STRENGTH CHARACTERISTICS 22 7.1 MECHANICAL STRENGTH SPECIFICATIONS 24 7.2 TEST CONDITIONS 24 7.3 DEFINITION OF TEST POINTS 24 8. PACKING 29 8.1 PACKING SPECIFICATIONS 29 8.2 PACKING METHOD 29 8.3 PALLET 20			
4.3.3 BACKLIGHT UNIT. 1 4.3.4 LIGHTBAR Connector Pin Assignment 1 4.4 LVDS INPUT SIGNAL SPECIFICATIONS 14 4.4.1 LVDS DATA MAPPING TABLE 1 4.4.2 COLOR DATA INPUT ASSIGNMENT 1 4.5 DISPLAY TIMING SPECIFICATIONS 16 4.6 POWER ON/OFF SEQUENCE 16 5. OPTICAL CHARACTERISTICS 15 5.1 TEST CONDITIONS 15 5.2 OPTICAL SPECIFICATIONS 15 6. RELIABILITY TEST ITEM 25 7. MECHANICAL STRENGTH CHARACTERISTICS 26 7.2 TEST CONDITIONS 26 7.2 TEST CONDITIONS 26 7.3 DEFINITION OF TEST POINTS 26 8. PACKING 26 8.1 PACKING SPECIFICATIONS 26 8.2 PACKING METHOD 29 8.3 PALLET 20			
4.3.4 LIGHTBAR Connector Pin Assignment 1 4.4 LVDS INPUT SIGNAL SPECIFICATIONS 14 4.4.1 LVDS DATA MAPPING TABLE 1 4.4.2 COLOR DATA INPUT ASSIGNMENT 1 4.5 DISPLAY TIMING SPECIFICATIONS 16 4.6 POWER ON/OFF SEQUENCE 18 5. OPTICAL CHARACTERISTICS 19 5.1 TEST CONDITIONS 15 5.2 OPTICAL SPECIFICATIONS 15 6. RELIABILITY TEST ITEM 25 7. MECHANICAL STRENGTH CHARACTERISTICS 26 7.2 TEST CONDITIONS 26 7.2 TEST CONDITIONS 26 7.3 DEFINITION OF TEST POINTS 26 8. PACKING 26 8.1 PACKING SPECIFICATIONS 29 8.2 PACKING METHOD 29 8.3 PALLET 20		·	
4.4 LVDS INPUT SIGNAL SPECIFICATIONS 14 4.4.1 LVDS DATA MAPPING TABLE 1 4.4.2 COLOR DATA INPUT ASSIGNMENT 1 4.5 DISPLAY TIMING SPECIFICATIONS 16 4.6 POWER ON/OFF SEQUENCE 18 5. OPTICAL CHARACTERISTICS 19 5.1 TEST CONDITIONS 19 5.2 OPTICAL SPECIFICATIONS 19 6. RELIABILITY TEST ITEM 20 7. MECHANICAL STRENGTH CHARACTERISTICS 20 7.1 MECHANICAL STRENGTH SPECIFICATIONS 20 7.2 TEST CONDITIONS 20 7.3 DEFINITION OF TEST POINTS 20 8. PACKING 20 8.1 PACKING SPECIFICATIONS 20 8.2 PACKING METHOD 20 8.3 PALLET 20			
4.4.1 LVDS DATA MAPPING TABLE 1 4.4.2 COLOR DATA INPUT ASSIGNMENT 1 4.5 DISPLAY TIMING SPECIFICATIONS 16 4.6 POWER ON/OFF SEQUENCE 18 5. OPTICAL CHARACTERISTICS 19 5.1 TEST CONDITIONS 19 5.2 OPTICAL SPECIFICATIONS 19 6. RELIABILITY TEST ITEM 20 7.1 MECHANICAL STRENGTH CHARACTERISTICS 20 7.2 TEST CONDITIONS 20 7.3 DEFINITION OF TEST POINTS 20 8. PACKING 20 8.1 PACKING SPECIFICATIONS 20 8.2 PACKING METHOD 20 8.3 PALLET 20			
4.4.2 COLOR DATA INPUT ASSIGNMENT 1 4.5 DISPLAY TIMING SPECIFICATIONS 16 4.6 POWER ON/OFF SEQUENCE 18 5. OPTICAL CHARACTERISTICS 19 5.1 TEST CONDITIONS 19 5.2 OPTICAL SPECIFICATIONS 19 6. RELIABILITY TEST ITEM 22 7. MECHANICAL STRENGTH CHARACTERISTICS 24 7.1 MECHANICAL STRENGTH SPECIFICATIONS 24 7.2 TEST CONDITIONS 24 7.3 DEFINITION OF TEST POINTS 24 8. PACKING 25 8.1 PACKING SPECIFICATIONS 25 8.2 PACKING METHOD 25 8.3 PALLET 26			
4.5 DISPLAY TIMING SPECIFICATIONS 16 4.6 POWER ON/OFF SEQUENCE 18 5. OPTICAL CHARACTERISTICS 19 5.1 TEST CONDITIONS 19 5.2 OPTICAL SPECIFICATIONS 19 6. RELIABILITY TEST ITEM 20 7. MECHANICAL STRENGTH CHARACTERISTICS 20 7.1 MECHANICAL STRENGTH SPECIFICATIONS 20 7.2 TEST CONDITIONS 20 7.3 DEFINITION OF TEST POINTS 20 8. PACKING 29 8.1 PACKING SPECIFICATIONS 29 8.2 PACKING METHOD 20 8.3 PALLET 20			
4.6 POWER ON/OFF SEQUENCE 18 5. OPTICAL CHARACTERISTICS 19 5.1 TEST CONDITIONS 19 5.2 OPTICAL SPECIFICATIONS 19 6. RELIABILITY TEST ITEM 23 7. MECHANICAL STRENGTH CHARACTERISTICS 24 7.1 MECHANICAL STRENGTH SPECIFICATIONS 24 7.2 TEST CONDITIONS 24 7.3 DEFINITION OF TEST POINTS 26 8. PACKING 29 8.1 PACKING SPECIFICATIONS 29 8.2 PACKING METHOD 29 8.3 PALLET 20			
5. OPTICAL CHARACTERISTICS 19 5.1 TEST CONDITIONS 19 5.2 OPTICAL SPECIFICATIONS 19 6. RELIABILITY TEST ITEM 20 7. MECHANICAL STRENGTH CHARACTERISTICS 24 7.1 MECHANICAL STRENGTH SPECIFICATIONS 24 7.2 TEST CONDITIONS 24 7.3 DEFINITION OF TEST POINTS 24 8. PACKING 29 8.1 PACKING SPECIFICATIONS 29 8.2 PACKING METHOD 29 8.3 PALLET 20			
5.1 TEST CONDITIONS 19 5.2 OPTICAL SPECIFICATIONS 19 6. RELIABILITY TEST ITEM 20 7. MECHANICAL STRENGTH CHARACTERISTICS 20 7.1 MECHANICAL STRENGTH SPECIFICATIONS 20 7.2 TEST CONDITIONS 20 7.3 DEFINITION OF TEST POINTS 20 8. PACKING 20 8.1 PACKING SPECIFICATIONS 20 8.2 PACKING METHOD 20 8.3 PALLET 20			
5.2 OPTICAL SPECIFICATIONS 19 6. RELIABILITY TEST ITEM 20 7. MECHANICAL STRENGTH CHARACTERISTICS 24 7.1 MECHANICAL STRENGTH SPECIFICATIONS 24 7.2 TEST CONDITIONS 24 7.3 DEFINITION OF TEST POINTS 24 8. PACKING 25 8.1 PACKING SPECIFICATIONS 25 8.2 PACKING METHOD 25 8.3 PALLET 26	5.		
6. RELIABILITY TEST ITEM 23 7. MECHANICAL STRENGTH CHARACTERISTICS 24 7.1 MECHANICAL STRENGTH SPECIFICATIONS 24 7.2 TEST CONDITIONS 24 7.3 DEFINITION OF TEST POINTS 24 8. PACKING 25 8.1 PACKING SPECIFICATIONS 25 8.2 PACKING METHOD 25 8.3 PALLET 26			
7. MECHANICAL STRENGTH CHARACTERISTICS 24 7.1 MECHANICAL STRENGTH SPECIFICATIONS 24 7.2 TEST CONDITIONS 24 7.3 DEFINITION OF TEST POINTS 24 8. PACKING 25 8.1 PACKING SPECIFICATIONS 25 8.2 PACKING METHOD 25 8.3 PALLET 26			
7.1 MECHANICAL STRENGTH SPECIFICATIONS 24 7.2 TEST CONDITIONS 24 7.3 DEFINITION OF TEST POINTS 24 8. PACKING 25 8.1 PACKING SPECIFICATIONS 25 8.2 PACKING METHOD 25 8.3 PALLET 26			
7.2 TEST CONDITIONS 24 7.3 DEFINITION OF TEST POINTS 24 8. PACKING 25 8.1 PACKING SPECIFICATIONS 25 8.2 PACKING METHOD 25 8.3 PALLET 26	7.		
7.3 DEFINITION OF TEST POINTS 24 8. PACKING 25 8.1 PACKING SPECIFICATIONS 25 8.2 PACKING METHOD 25 8.3 PALLET 26			
8. PACKING 29 8.1 PACKING SPECIFICATIONS 29 8.2 PACKING METHOD 29 8.3 PALLET 20			
8.1 PACKING SPECIFICATIONS		7.3 DEFINITION OF TEST POINTS	. 24
8.2 PACKING METHOD 29 8.3 PALLET 20	8.		
8.3 PALLET			
8.4 UN-PACKAGING METHOD2			
		8.4 UN-PACKAGING METHOD	. 27



9. INNOLUX MODULE LABEL	28
10. PRECAUTIONS	29
10.1 ASSEMBLY AND HANDLING PRECAUTIONS	29
10.2 STORAGE PRECAUTIONS	29
10.3 OPERATION PRECAUTIONS	29
10.4 SAFETY PRECAUTIONS	29
10.5 SAFETY STANDARDS	30
10.6 OTHER	30
Appendix. SYSTEM COVER DESIGN NOTICE	30
Appendix. OUTLINE DRAWING	33



REVISION HISTORY

Version	Date	Section	Description			
1.0	2017,11.15	All	Approve Specification was first issued for Dell			
2.0	2018,02,12	10	4.3.1 LCD ELETRONICS SPECIFICATION Power Consumption Typ: 3.48W→3.625 4.5 DISPLAY TIMING SPECIFICATIONS Vertical Display Term Frame Rate: Max 75 Hz→77 Hz, V-Total: 1257→1300			
		5	2. MECHANICAL SPECIFICATIONS Adding Weight: min 2039 max:2397			
		19	Modified Color Chromaticity Rx,Ry Gx,Gy Bx,By			



1. GENERAL DESCRIPTION

1.1 OVERVIEW

M238HCA-L5Z is a 23.8" TFT Liquid Crystal Display module with WLED Backlight unit and 30 pins 2ch-LVDS interface. This module supports 1920 x 1080 Full HD mode and can display up to 16.7M colors. The converter module for Backlight is not built in.

1.2 GENERAL SPECIFICATIONS

Item	Specification	Unit	Note
Screen Size	23.8" real diagonal		
Driver Element	a-si TFT active matrix	-	-
Pixel Number	1920 x R.G.B. x 1080	pixel	-
Pixel Pitch	0.2745 (H) x 0.2745 (V)	mm	-
Pixel Arrangement	RGB vertical stripe	-	ı
Display Colors	16.7M	color	-
Transmissive Mode	Normally black	-	
Surface Treatment	AG type, 3H hard coating, Haze 25	-	-
Luminance, White	250	Cd/m2	
Color Gamut	72% of NTSC(Typ.)	-	
ROHS, Halogen Free &TCO 7.0	ROHS, Halogen Free TCO 7.0 Compliance	-	
Power Consumption	Total 15.225W(Max.)@cell 3.625W (Typ.), BL 11.	6W (Typ.)	(1)

Note (1) The specified power consumption: Total= cell (reference 4.3.1)+BL (reference 4.3.3)

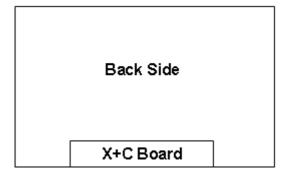
2. MECHANICAL SPECIFICATIONS

Item		Min.	Тур.	Max.	Unit	Note
	Horizontal (H)	534.5	535	536	mm	
Module Size	Vertical (V)	312.5	313	314	mm	(1)
	Thickness (T)	11	12	13	mm	
Bezel Area	Horizontal	-	-	-	mm	
	Vertical	-	-	-	mm	
Active Area	Horizontal	-	527.04	-	mm	
	Vertical	-	296.46	-	mm	
Weight		(2039)	(2266)	(2397)	g	

Note (1) Please refer to the attached drawings for more information of front and back outline dimensions.

Thickness(T) of LB CNT is 12.5mm(Typ)

Note (2)







3. ABSOLUTE MAXIMUM RATINGS

3.1 ABSOLUTE RATINGS OF ENVIRONMENT

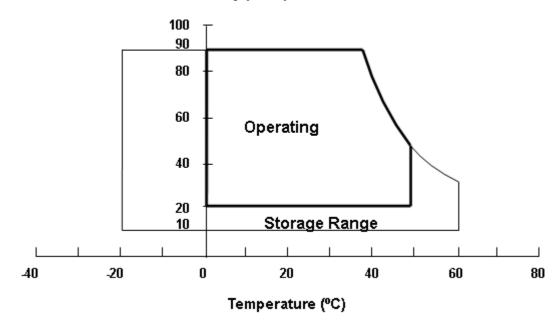
ltom	Cumbal	Va	lue	l loit	Note	
Item	Symbol	Min.	Max.	Unit		
Storage Temperature	TST	-20	60	°C	(1)	
Operating Ambient Temperature	TOP	0	50	۰C	(1), (2)	

Note (1)

- (a) 90 %RH Max.
- (b) Wet-bulb temperature should be 39 °C Max.
- (c) No condensation.

Note (2) Panel surface temperature should be 0° C min. and 65° C max under Vcc=5.0V, Input fr =60Hz, typical LED string current, 25° C ambient temperature, and no humidity control. Any condition of ambient operating temperature, the surface of active area should be keeping not higher than 65° C.

Relative Humidity (%RH)





3.2 ELECTRICAL ABSOLUTE RATINGS

3.2.1 TFT LCD MODULE

Item	Symbol		ue	Unit	Note	
		Min.	Max.			
Power Supply Voltage	VCCS	-0.3	6.0	V	(1)	
Logic Input Voltage	V _{IN}	-0.3	3.6	V	(1)	

3.2.2 BACKLIGHT UNIT

Item	Symbol	Value			Unit	Note	
item	Symbol	Min.	Тур	Max.	Offic	Note	
LED Forward Current Per Input Pin	l _F	95	100	105	mA	(1), (2) Duty=100%	
LED Pulse Forward Current Per Input Pin	I _P			500	mA	(1), (2) Pulse Width≦10msec. and Duty≦25%	

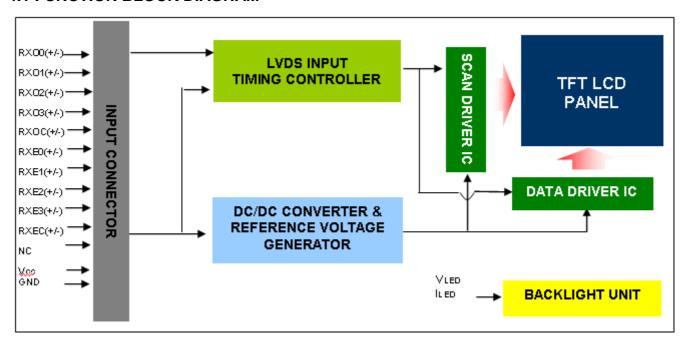
Note (1) Permanent damage to the device may occur if maximum values are exceeded. Function operation should be restricted to the conditions described under Normal Operating Conditions.

Note (2) Specified values are for input pin of LED light bar at Ta=25±2 °C (Refer to 4.3.3 and 4.3.4 for further information).



4. ELECTRICAL SPECIFICATIONS

4.1 FUNCTION BLOCK DIAGRAM



4.2. INTERFACE CONNECTIONS

PIN ASSIGNMENT

Pin	Name	Description
1	RXO0-	Negative LVDS differential data input. Channel O0 (odd)
2	RXO0+	Positive LVDS differential data input. Channel O0 (odd)
3	RXO1-	Negative LVDS differential data input. Channel O1 (odd)
4	RXO1+	Positive LVDS differential data input. Channel O1 (odd)
5	RXO2-	Negative LVDS differential data input. Channel O2 (odd)
6	RXO2+	Positive LVDS differential data input. Channel O2 (odd)
7	GND	Ground
8	RXOC-	0.000
		Negative LVDS differential clock input. (odd)
9	RXOC+	Positive LVDS differential clock input. (odd)
10	RXO3-	Negative LVDS differential data input. Channel O3(odd)
11	RXO3+	Positive LVDS differential data input. Channel O3 (odd)
12	RXE0-	Negative LVDS differential data input. Channel E0 (even)
13	RXE0+	Positive LVDS differential data input. Channel E0 (even)
14	GND	Ground
15	RXE1-	Negative LVDS differential data input. Channel E1 (even)
16	RXE1+	Positive LVDS differential data input. Channel E1 (even)
17	GND	Ground
18	RXE2-	Negative LVDS differential data input. Channel E2 (even)
19	RXE2+	Positive LVDS differential data input. Channel E2 (even)
20	RXEC-	Negative LVDS differential clock input. (even)
21	RXEC+	Positive LVDS differential clock input. (even)
22	RXE3-	Negative LVDS differential data input. Channel E3 (even)
23	RXE3+	Positive LVDS differential data input. Channel E3 (even)
24	GND	Ground
25	NC	For LCD internal use only, Do not connect



Pin	Name	Description
26	NC	For LCD internal use only, Do not connect
27	NC	For LCD internal use only, Do not connect
28	Vcc	+5.0V power supply
29	Vcc	+5.0V power supply
30	Vcc	+5.0V power supply

Note (1) Connector Part No.:

P-TWO: 187114-30091 or equivalent.

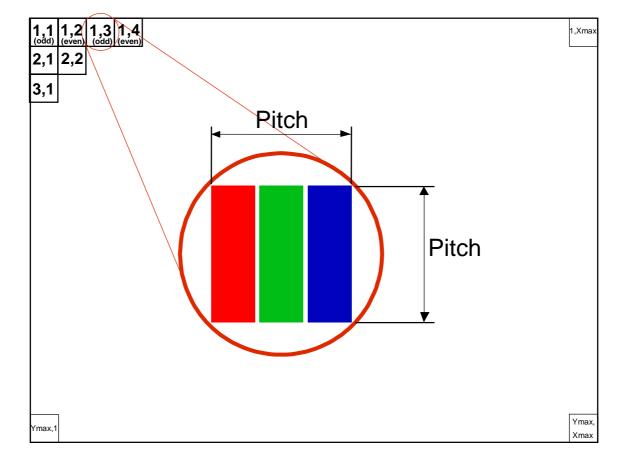
Note (2) User's connector Part No:

Mating Wire Cable Connector Part No.: FI-X30H(JAE) or FI-X30HL(JAE)

Mating FFC Cable Connector Part No.: 217007-013001 (P-TWO) or JF05X030-1 (JAE).

Note (3) The first pixel is odd.

Note (4) Input signal of even and odd clock should be the same timing.





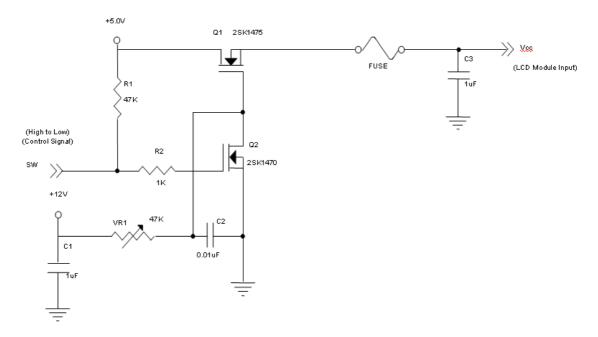
4.3 ELECTRICAL CHARACTERISTICS

4.3.1 LCD ELETRONICS SPECIFICATION

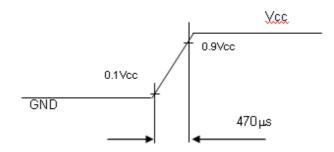
Parame	tor	Symbol		Value		Unit	Note
Palaille	riei	Symbol	Min.	Тур.	Max.	Offic	Note
Power Supply	/ Voltage	Vcc	4.5	5.0	5.5	V	-
Ripple Vo	ltage	V_{RP}	-	-	300	mV	-
Rush Cui	rent	I _{RUSH}	-	-	3	Α	(2)
	White		•	0.556	0.642	Α	(3)a
Power Supply Current	Black		•	0.551	0.637	Α	(3)b
	Vertical Stripe		•	0.725	0.852	Α	(3)c
Power Cons	umption	PLCD	•	3.625	4.26	W	(4)
LVDS differential	input voltage	Vid	100	-	600	mV	
LVDS common in	Vcm	1.0	1.2	1.4	V		
LVDS Logic High Input Voltage			-	-	0.1	V	
LVDS Logic Low I	nput Voltage	VIL	-0.1	-		V	

Note (1) The ambient temperature is $Ta = 25 \pm 2$ °C.

Note (2) Measurement Conditions:

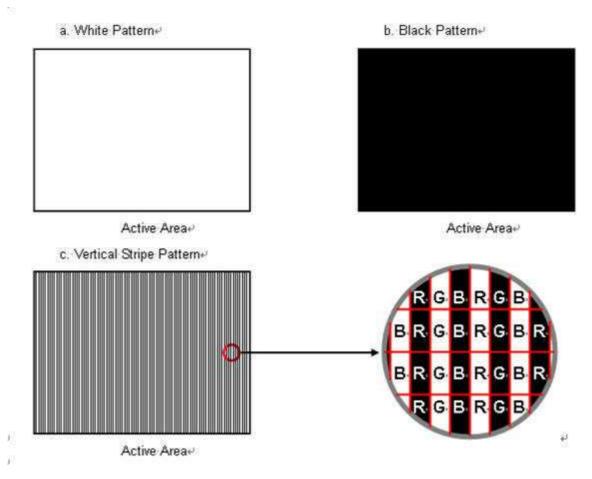


Vcc rising time is 470µs





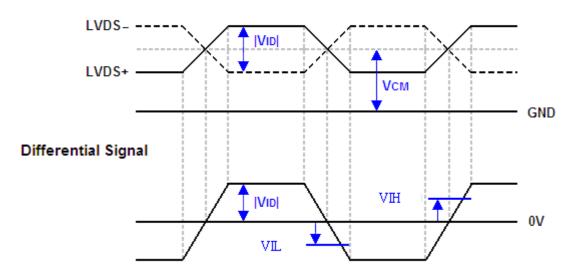
Note (3) The specified max power supply current is under the conditions at Vcc = 5.0 V, $Ta = 25 \pm 2 \,^{\circ}\text{C}$, Fr = 60Hz, whereas a power dissipation check pattern below is displayed.



Note (4) The power consumption is specified at the pattern with the maximum current.

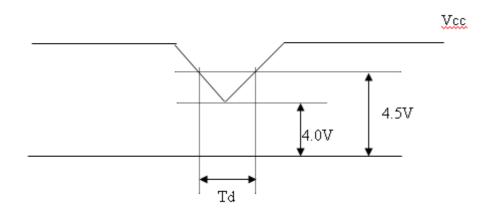
Note (5) VID waveform condition

Single-end Signals





4.3.2 Vcc Power Dip Condition



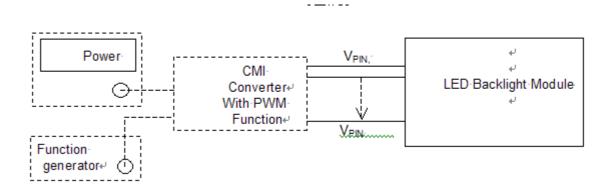
Dip condition:4.0 ≦ Vcc ≦ 4.5, Td ≦ 20ms

4.3.3 BACKLIGHT UNIT

Parameter	Symbol		Value	Unit	Note	
Parameter	Symbol	Min.	Тур.	Max.	Offic	Note
LED Light Bar Input Voltage Per Input Pin	VPIN	25.9	29	32	V	(1), Duty=100%, IPIN=100mA
LED Light Bar Current Per Input Pin	IPIN	95	100	105	mA	(1), (2) Duty=100%
LED Life Time	LLED	30000			Hrs	(3)
Power Consumption	PBL		11.6	12.8	W	(1) Duty=100%, IPIN=100mA

Note (1) LED light bar input voltage and current are measured by utilizing a true RMS multimeter as shown below:

Note (2) PBL(Typ) = IPIN(Typ) \times VPIN(Typ) \times (4) PBL(Max) = IPIN(TYP) \times VPIN(Max) \times (4) input pins.. Note (3) The lifetime of LED is defined as the time when LED packages continue to operate under the conditions at Ta = 25 \pm 2 $^{\circ}$ C and I= (100)mA (per chip) until the brightness becomes \leq 50% of its original value.

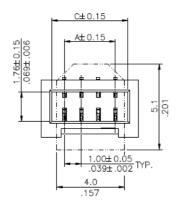


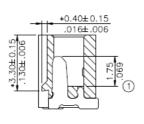
Version 2.0 13 February 2018 12 / 35

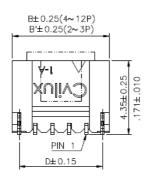


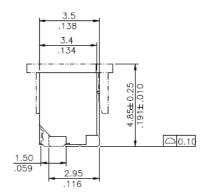
4.3.4 LIGHTBAR Connector Pin Assignment

Connector: CI1406M1VL0-NH (CviLux) or Compatible









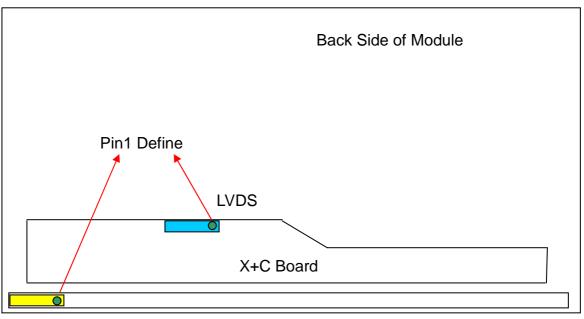
CN1

Pin number	Description
1	Cathode of LED string
2	Cathode of LED string
3	VLED
4	VLED
5	Cathode of LED string
6	Cathode of LED string

Note(1) Connector(wire type): CI1406M1VL0-NH (CviLux) or equivalent.

Note(2) User's mating connector part No.: FCN(WF1300106-B) and hook width must be less than 4.5mm.





Light Bar

4.4 LVDS INPUT SIGNAL SPECIFICATIONS

4.4.1 LVDS DATA MAPPING TABLE

LVDS Channel O0	LVDS output	D7	D6	D4	D3	D2	D1	D0
LVD3 Charmer 00	Data order	OG0	OR5	OR4	OR3	OR2	OR1	OR0
LVDS Channel O1	LVDS output	D18	D15	D14	D13	D12	D9	D8
LVD3 Channel O1	Data order	OB1	OB0	OG5	OG4	OG3	OG2	OG1
LVDS Channel O2	LVDS output	D26	D25	D24	D22	D21	D20	D19
LVD3 Channel 02	Data order	DE	NA	NA	OB5	OB4	OB3	OB2
LVDS Channel O3	LVDS output	D23	D17	D16	D11	D10	D5	D27
LVD3 Channel O3	Data order	NA	OB7	OB6	OG7	OG6	OR7	OR6
LVDS Channel E0	LVDS output	D7	D6	D4	D3	D2	D1	D0
LVD3 Charmer EU	Data order	EG0	ER5	ER4	ER3	ER2	ER1	ER0
LVDS Channel E1	LVDS output	D18	D15	D14	D13	D12	D9	D8
LVDS Channel E1	Data order	EB1	EB0	EG5	EG4	EG3	EG2	EG1
LVDS Channel E2	LVDS output	D26	D25	D24	D22	D21	D20	D19
LVD3 Channel E2	Data order	DE	NA	NA	EB5	EB4	EB3	EB2
LVDS Channel E3	LVDS output	D23	D17	D16	D11	D10	D5	D27
LVD3 CHAIIIIEI E3	Data order	NA	EB7	EB6	EG7	EG6	ER7	ER6



4.4.2 COLOR DATA INPUT ASSIGNMENT

The brightness of each primary color (red, green and blue) is based on the 8-bit gray scale data input for the color. The higher the binary input, the brighter the color. The table below provides the assignment of color versus data input.

												Da		Sigr											
	Color				Re	ed								reer	1						Βlι	Je			
	Coloi	R7	R6	R5	R4	R3	R2	R1	R0	G 7	G 6	G 5	G 4	G3	G2	G1	G0	В 7	В6	В5	В4	ВЗ	B2	B 1	B 0
	Black	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
	Red	1	1	1	1	1	1	1	1	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
Rasic	Green	0	0	0	0	0	0	0	0	1	1	1	1	1	1	1	1	0	0	0	0	0	0	0	0
Basic	Blue	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	1	1	1	1	1	1	1	1
Colors	Cyan	0	0	0	0	0	0	0	0	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1
	Magenta	1	1	1	1	1	1	1	1	0	0	0	0	0	0	0	0	1	1	1	1	1	1	1	1
	Yellow	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	0	0	0	0	0	0	0	0
	White	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1
	Red(0) / Dark	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
	Red(1)	0	0	0	0	0	0	0	1	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
Gray	Red(2)	0	0	0	0	0	0	1	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
Scale	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:
Of	:	:	:	:	:	:		:		:		:		:	:	:			:		:	:	:	:	
Red	Red(253)	1	1	1	1	1	1	0	1	0	0	0	:0	0	0	0	0	0	0	0	0	0	0	0	:0
Neu	Red(254)	1	1	1	1	1	1	1	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
	Red(255)	1	1	1	1	1	1	1	1	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
	Green(0) / Dark	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
	Green(1)	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	1	0	0	0	0	0	0	0	0
Gray	Green(2)	0	0	0	0	0	0	0	0	0	0	0	0	0	0	1	0	0	0	0	0	0	0	0	0
Scale	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:
Of	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:
Green	Green(253)	0	0	0	0	0	0	0	0	1	1	1	1	1	1	0	1	0	0	0	0	0	0	0	0
010011	Green(254)	0	0	0	0	0	0	0	0	1	1	1	1	1	1	1	0	0	0	0	0	0	0	0	0
	Green(255)	0	0	0	0	0	0	0	0	1	1	1	1	1	1	1	1	0	0	0	0	0	0	0	0
	Blue(0) / Dark	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
	Blue(1)	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	1
Gray	Blue(2)	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	1	0
Scale	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:
Of	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:
Blue	Blue(253)	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	1	1	1	1	1	1	0	1
	Blue(254)	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	1	1	1	1	1	1	1	0
	Blue(255)	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	1	1	1	1	1	1	1	1

Note (1) 0: Low Level Voltage, 1: High Level Voltage



4.5 DISPLAY TIMING SPECIFICATIONS

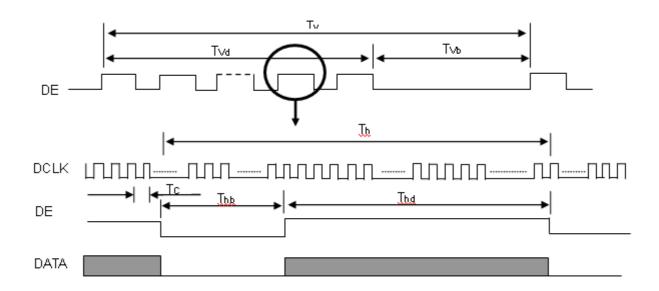
The input signal timing specifications are shown as the following table and timing diagram.

Signal	Item	Symbol	Min.	Тур.	Max.	Unit	Note
	Frequency	Fc	56	74.25	97.98	MHz	-
	Period	Tc	-	13.47	-	ns	
	Input cycle to cycle jitter	T_{rcl}	-0.02*Tc	-	0.02*Tc	ns	(1)
	Input Clock to data skew	TLVCCS	-0.02*Tc	-	0.02*Tc	ps	(2)
LVDS Clock	Spread spectrum modulation range	F_{clkin_mod}	0.97*Fc	-	1.03*Fc	MHz	(2)
	Spread spectrum modulation frequency	F _{SSM}	-	-	100	KHz	- (3)
	Frame Rate	Fr	49	60	77	Hz	Tv=Tvd+Tvb
	Total	Tv	1100	1125	1300	Th	-
Vertical Display Term	Active Display	Tvd	1080	1080	1080	Th	-
	Blank	Tvb	20	45	220	Th	-
	Total	Th	1015	1100	1150	Tc	Th=Thd+Thb
Horizontal Display Term	Active Display	Thd	960	960	960	Тс	-
	Blank	Thb	55	140	190	Tc	-

Note: Because this module is operated by DE only mode, Hsync and Vsync input signals are ignored.

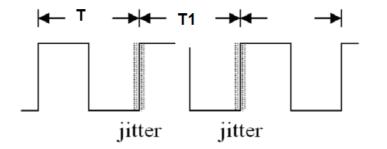
Please make sure the range of pixel clock has follow the below equation and Fc, Fr, Tv, Th not allowed to get beyond the min or max spec.

INPUT SIGNAL TIMING DIAGRAM

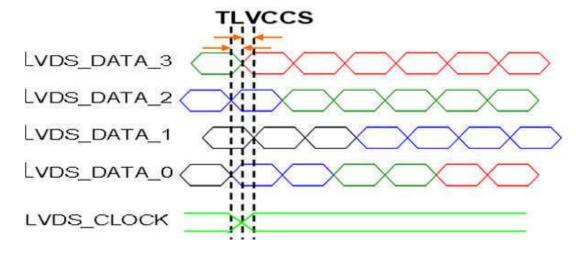




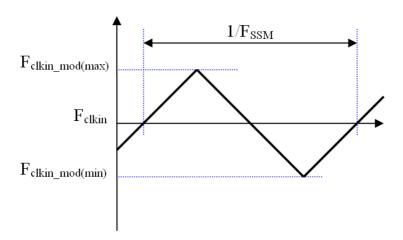
Note (1) The input clock cycle-to-cycle jitter is defined as below figures. Trcl = $IT_1 - TI$



Note (2) Input Clock to data skew is defined as below figures.



Note (3) The SSCG (Spread spectrum clock generator) is defined as below figures.



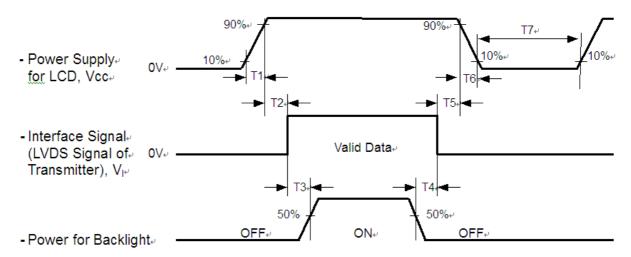
Note(4) The DCLK range at last line of V-blank should be set in 0 to Hdisplay/2

Version 2.0 13 February 2018 17 / 35



4.6 POWER ON/OFF SEQUENCE

The power sequence specifications are shown as the following table and diagram.



Timing Specifications:

Parameters		Units		
Farameters	Min	Тур.	Max	UTIILS
T1	0.5	-	10	ms
T2	0	30	50	ms
T3	450	-	-	ms
T4	100	250	-	ms
T5	0	20	50	ms
T6	0.1	-	100	ms
T7	1000	-	-	ms

- Note (1) The supply voltage of the external system for the module input should be the same as the definition of Vcc.
- Note (2) When the backlight turns on before the LCD operation of the LCD turns off, the display may momentarily become abnormal screen.
- Note (3) In case of VCC = off level, please keep the level of input signals on the low or keep a high impedance.
- Note (4) T7 should be measured after the module has been fully discharged between power off and on period.
- Note (5) Interface signal shall not be kept at high impedance when the power is on.
- Note (6) CMI won't take any responsibility for the products which are damaged by the customers not following the Power Sequence.
- Note (7) There might be slight electronic noise when LCD is turned off (even backlight unit is also off). To avoid this symptom, we suggest "Vcc falling timing" to follow "t6 spec".



5. OPTICAL CHARACTERISTICS

5.1 TEST CONDITIONS

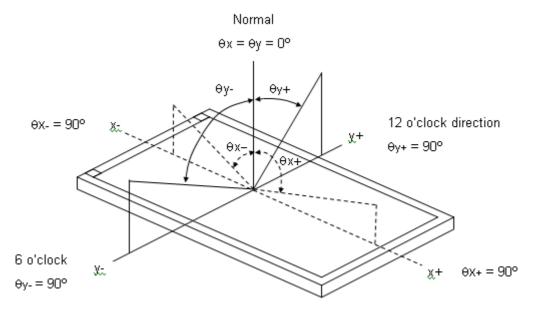
Item	Symbol	Value	Unit
Ambient Temperature	Ta	25±2	°C
Ambient Humidity	На	50±10	%RH
Supply Voltage	V_{CC}	5	V
Input Signal	According to typical va	alue in "3. ELECTRICAL (CHARACTERISTICS"
LED Light Bar Input Current Per Input Pin	I _{PIN}	100	mA _{DC}
PWM Duty Ratio	D	100	%
LED Light Bar Test Converter		CMI 35-D080484	•

5.2 OPTICAL SPECIFICATIONS

The relative measurement methods of optical characteristics are shown in 5.2. The following items should be measured under the test conditions described in 5.1 and stable environment shown in Note (5).

Iter	n	Symbol	Condition	Min.	Тур.	Max.	Unit	Note
	Red	Rx			0.651			
	Red	Ry			0.340			
	Green	Gx			0.323			
Color	Green	Gy		Тур –	0.615	Typ +		(1) (E)
Chromaticity (CIE 1931)	Blue	Bx	$\theta_x=0^\circ, \ \theta_Y=0^\circ$	0.03	0.156	0.03	_	(1), (5)
(0.2 :00:)	Diue	Ву	CS-2000 R=G=B=255		0.046			
	VA/I . 'C -	Wx	Gray scale		0.313			
	White	Wy	•		0.329			
Center Lumina (Center of		L _C		200	250	-	cd/m ²	(4), (5)
Contrast	Ratio	CR		700	1000	-	-	(2), (5)
		TR		-	8	13		
Respons	e Time	T _F	$\theta_x=0^\circ, \ \theta_Y=0^\circ$		7	12	ms	(3)
		T _{GtG_AVE}		-	14			
White Variation		δW	$\theta_x=0^\circ, \ \theta_Y=0^\circ$	75			%	(5), (6)
Viewing Angle	Viewing Angle Horizontal		CR ≧ 10	170	178	-	Deg.	(1) (5)
viewing Angle	Vertical	θ y- + θ y+	ON ≦ 10	170	178	-	Deg.	(1), (5)

Note (1) Definition of Viewing Angle (θx , θy):



Note (2) Definition of Contrast Ratio (CR):

The contrast ratio can be calculated by the following expression.

Contrast Ratio (CR) = L255 / L0

L255: Luminance of gray level 255

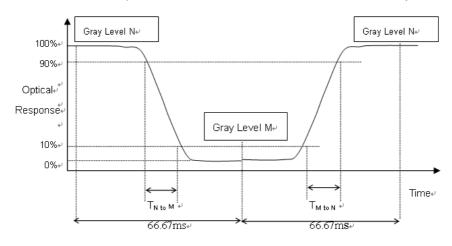
L 0: Luminance of gray level 0

CR = CR (5)

CR (X) is corresponding to the Contrast Ratio of the point X at Figure in Note (6).

Note (3) Definition of Response Time:

- -The T_R is the rising-time means the transition time from "Full-Black (gray 0)" to "Full-White (gray 255)" and the T_F is the falling-time means the transition time from "Full-White (gray 255)" to "Full-White (gray 0)" as the following figure.(Measured by TEKTRONIX TDS3054B).
- -The T_{GtG} is the response time means the transition time from "Gray N" to "Gray M" (N,M=0~255).





- T_{GtG AVE} is the total average of the T_{GtG} data (Measured by INX GTG instrument)
- The gray (N,M) stands for the (0,31,63,~255) as the following table.
- If system uses ODC (Over Driving Circuit) function, $T_{\text{GtG_AVE}}$ may be 5ms~10ms.
- * It depends on Overshoot rate.

Gray to	Cray		Rising time									
Gray to	Glay	0	31	63	95	127	159	191	223	255		
	0											
	31											
1 [63											
1 [95											
Falling time	127											
1 [159											
1 [191							/				
1 [223											
	255											

Note (4) Definition of Luminance of White (L_C):

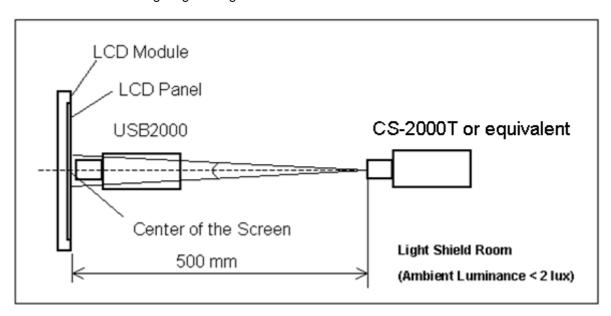
Measure the luminance of gray level 255 at center point

$$L_{\rm C} = L (5)$$

L(x) is corresponding to the luminance of the point X at Figure in Note (6).

Note (5) Measurement Setup:

The LCD module should be stabilized at given temperature for 40 minutes to avoid abrupt temperature change during measuring. In order to stabilize the luminance, the measurement should be executed after lighting Backlight for 40 minutes in a windless room.

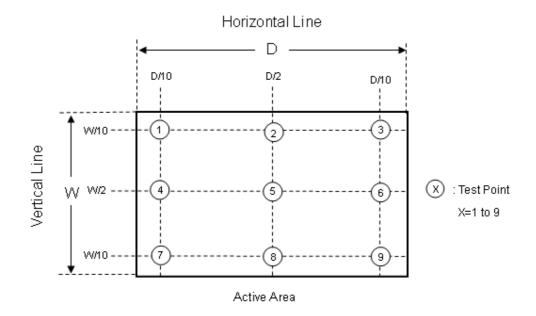


Note (6) Definition of White Variation (δW):

Measure the luminance of gray level 255 at 9 points

 $\delta W = Minimum [L (1) \sim L (9)] / Maximum [L (1) \sim L (9)]$







6. RELIABILITY TEST ITEM

Items	Required Condition	Note
Temperature Humidity Bias (THB)	Ta= 50℃ , 80%RH, 240hours	
High Temperature Operation (HTO)	Ta= 50 °C , 240hours	
Low Temperature Operation (LTO)	Ta= 0°C , 240hours	
High Temperature Storage (HTS)	Ta= 60°C , 240hours	
Low Temperature Storage (LTS)	Ta= -20°C , 240hours	
	Acceleration: 1.5 G	
	Wave: sine	
Vibration Test	Frequency: 10 - 300 Hz	
(Non-operation)	Sweep: 30 Minutes each Axis (X, Y, Z)	
	Acceleration: 50 G	
	Wave: Half-sine	
Shock Test	Active Time: 11 ms	
(Non-operation)	Direction: $\pm X$, $\pm Y$, $\pm Z$.(one time for each Axis)	
Thermal Shock Test (TST)	-20°C/30min , 60°C / 30min , 100 cycles	
On/Off Test	25° C ,On/10sec , Off /10sec , 30,000 cycles	
	Operation:10,000 ft / 24hours	
Altitude Test	Non-Operation:30,000 ft / 24hours	

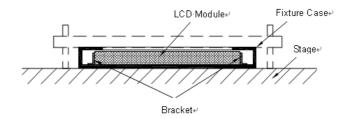
Note (1) criteria: Normal display image with no obvious non-uniformity and no line defect.

Note (2) Evaluation should be tested after storage at room temperature for more than two hour

Note (3) At testing Vibration and Shock, the fixture in holding the module has to be hard and rigid enough so that the module would not be twisted or bent by the fixture.

The fixing condition is shown as below:

At Room Temperature





7. MECHANICAL STRENGTH CHARACTERISTICS

7.1 MECHANICAL STRENGTH SPECIFICATIONS

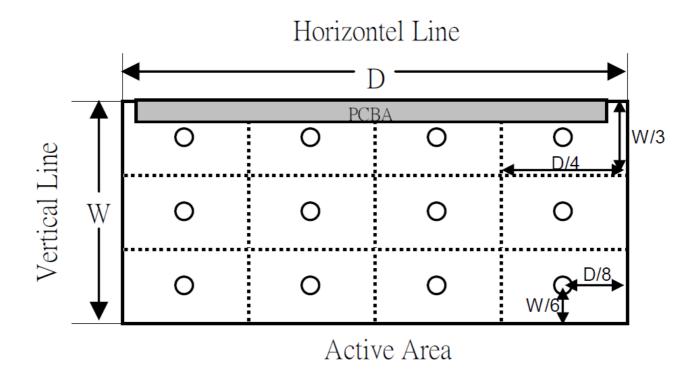
Item	Condition	Min	Unit	Note
Mechanical Strength	128 th Gray Pattern	0.6	Kgf	

7.2 TEST CONDITIONS

Items	Description	
Test Condition	Ambient Illumination: 10~15 lux Test Pattern: 128 Gray Distance of the judgment: 30cm from the surface of module Viewing angle of the judgment: Front	
Gage Information	1. Push pull guage a. Model name : HF-50, maker : ALGOL b. Shape of gage tip - Diameter : 2mm - Thickness : 2mm	
Definition of Minimum force	leakage that have occurred while operator presses on back side of module	

7.3 DEFINITION OF TEST POINTS

Measure the minimum force of test points at 128th Gray pattern. The test points at back side of module area is showing as below (If the test points on the PCBA or TP board, these points are not included).





8. PACKING

8.1 PACKING SPECIFICATIONS

(1) 12 LCD modules / 1 Box

(2) Box dimensions: 620(L) X 348(W) X 390(H) mm

(3) Weight: approximately: 28.8kg

8.2 PACKING METHOD

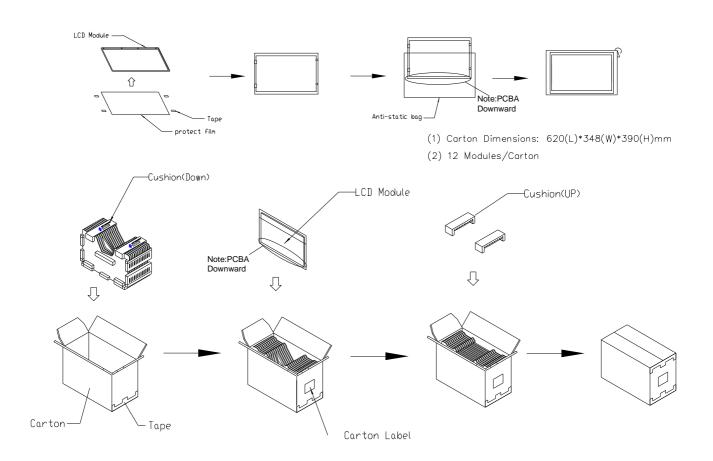


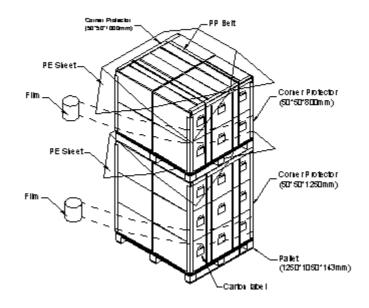
Figure. 7-1 Packing method



8.3 PALLET

For ocean shipping

Sea / Land Transportation (40ft HQ/40ft Container)



For air transport

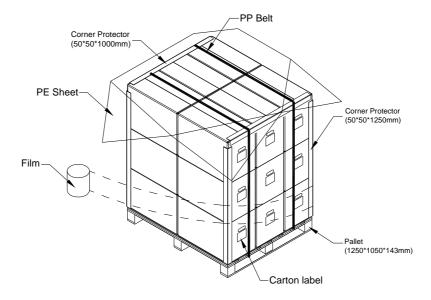


Figure. 7-2 Packing method



8.4 UN-PACKAGING METHOD

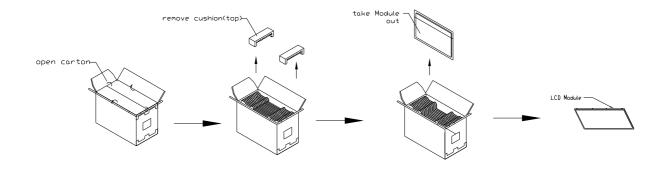


Figure. 8-3 Un-Packing method



9. INNOLUX MODULE LABEL

The barcode nameplate is pasted on each module as illustration, and its definitions are as following explanation.



(a) Model Name: M238HCA-L5Z

(b) Revision: Rev. XX, for example: A0, A1... B1, B2... or C1, C2...etc.

(c) Innolux barcode definition:

Serial ID: XX-XX-X-XX-YMD-L-NNNN

Code	Meaning	Description
XX	Innolux internal use	-
XX	Revision	Cover all the change
Х	Innolux internal use	-
XX	Innolux internal use	-
YMD	Year, month, day	Year: 0~9, 2001=1, 2002=2, 2003=32010=0, 2011=1, 2012=2 Month: 1~12=1, 2, 3, ~, 9, A, B, C Day: 1~31=1, 2, 3, ~, 9, A, B, C, ~, W, X, Y, exclude I, O, and U.
L	Product line #	Line 1=1, Line 2=2, Line 3=3,
NNNN	Serial number	Manufacturing sequence of product

(d) Customer's barcode definition:

Serial ID: CN-XXXXXX-XXXXX-YMD-L-NNN

Code	Meaning	Description
CN	Country	CN= China
XXXXXX	Dell PN	M238HCA-L5Z = 0F4YVC
XXXXX	Location Regent	IN200:NINGBO, INF00:NANHA
	Year, month, day	Year: 0~9, 2001=1, 2002=2, 2003=32010=0, 2011=1, 2012=2
YMD		Month: 1~12=1, 2, 3, ~, 9, A, B, C
		Day: 1~9, 11~31, A, ~, Y
L	Factory code	Eg :Ningbo A= A ; Ningbo B=B
NNN	Serial number	By LCD supplier

(e) FAB ID(UL Factory ID):

Region	Factory ID	
TWINX	GEMN	
NBINX	LEOO	
NBINX	VIRO	
NHINX	CAPG	

NNOLUX 群創光電

PRODUCT SPECIFICATION

10. PRECAUTIONS

10.1 ASSEMBLY AND HANDLING PRECAUTIONS

- (1) Do not apply rough force such as bending or twisting to the module during assembly.
- (2) To assemble or install module into user's system can be only in clean working areas. The dust and oil may cause electrical short or worsen the polarizer.
- (3) It's not permitted to have pressure or impulse on the module because the LCD panel and Backlight will be damaged.
- (4) Always follow the correct power sequence when LCD module is connecting and operating. This can prevent damage to the CMOS LSI chips during latch-up.
- (5) Do not pull the I/F connector in or out while the module is operating.
- (6) Do not disassemble the module.
- (7) Use a soft dry cloth without chemicals for cleaning, because the surface of polarizer is very soft and easily scratched.
- (8) It is dangerous that moisture come into or contacted the LCD module, because moisture may damage LCD module when it is operating.
- (9) High temperature or humidity may reduce the performance of module. Please store LCD module within the specified storage conditions.
- (10)When ambient temperature is lower than 10°C may reduce the display quality. For example, the response time will become slowly.

10.2 STORAGE PRECAUTIONS

- (1) Do not leave the module in high temperature, and high humidity for a long time. It is highly recommended to store the module with temperature from 0° to 35° and relative humidity of less than 70%
- (2) Do not store the TFT LCD module in direct sunlight
- (3) The module should be stored in dark place. It is prohibited to apply sunlight or fluorescent light in storing

10.3 OPERATION PRECAUTIONS

(1) The LCD product should be operated under normal condition.

Normal condition is defined as below:

Temperature : 20±15°C Humidity: 65±20%

Display pattern: continually changing pattern(Not stationary)

(2) If the product will be used in extreme conditions such as high temperature, high humidity, high altitude , display pattern or operation time etc... It is strongly recommended to contact Innolux for application engineering advice. Otherwise, Its reliability and function may not be guaranteed.

10.4 SAFETY PRECAUTIONS

- (1) If the liquid crystal material leaks from the panel, it should be kept away from the eyes or mouth. In case of contact with hands, skin or clothes, it has to be washed away thoroughly with soap.
- (2) After the module's end of life, it is not harmful in case of normal operation and storage.





10.5 SAFETY STANDARDS

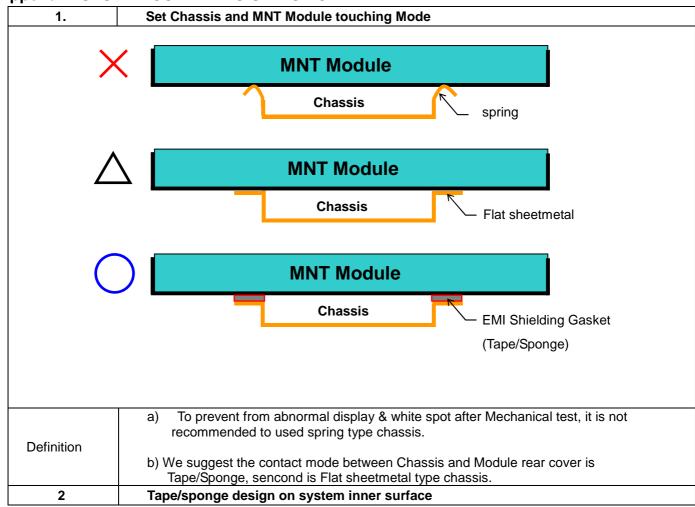
The LCD module should be certified with safety regulations as follows:

- (1) UL60950-1 or updated standard.
- (2) IEC60950-1 or updated standard.

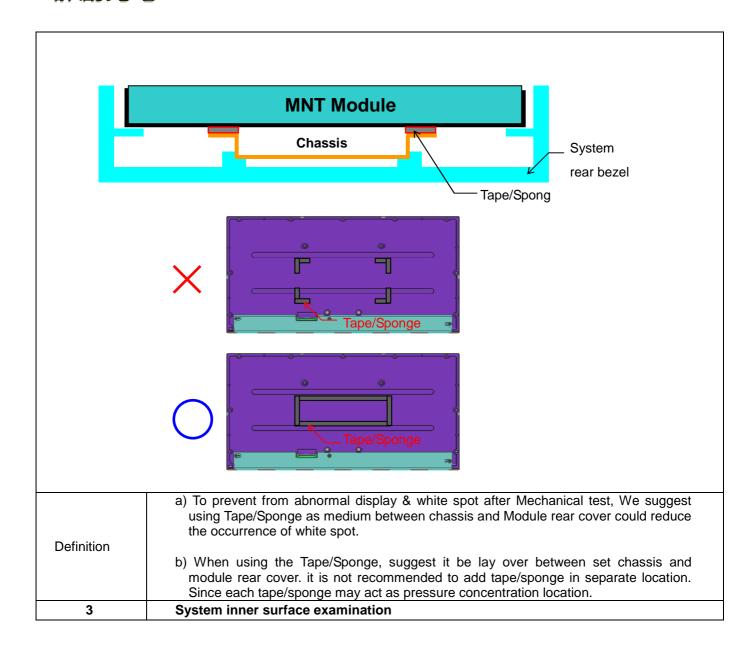
10.6 OTHER

When fixed patterns are displayed for a long time, remnant image is likely to occur.

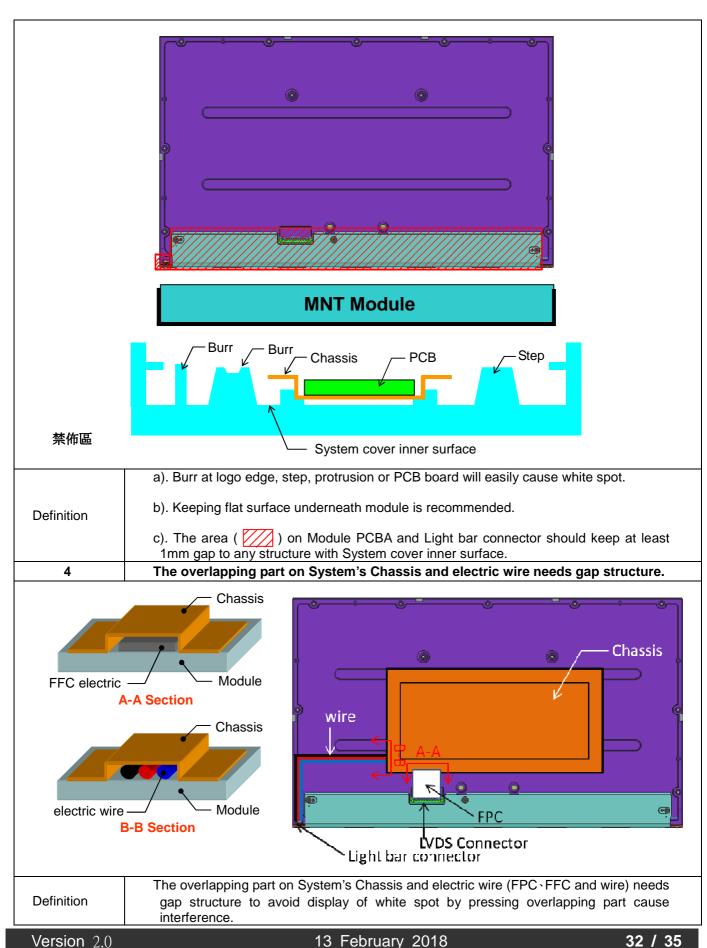
Appendix. SYSTEM COVER DESIGN NOTICE



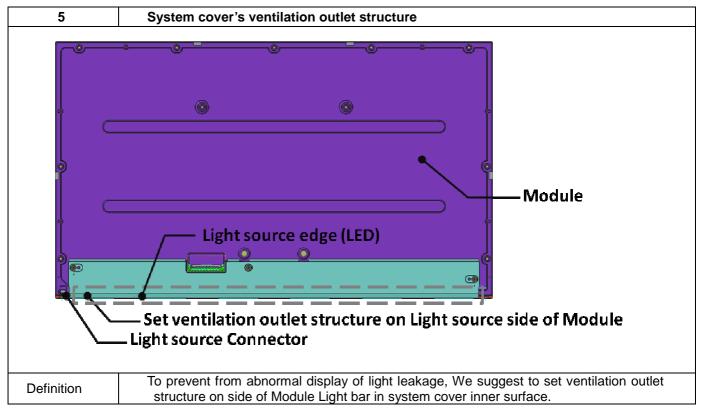












Appendix. OUTLINE DRAWING

